

# Low Noise/Low Power/2-Wire Bus



# X9429

# Single Digitally Controlled Potentiometer (XDCP™)

#### **FEATURES**

- Single Voltage Potentiometer
- 64 Resistor Taps
- 2-wire Serial Interface for write, read, and transfer operations of the potentiometer
- Wiper Resistance, 150Ω Typical at 5V
- Non-Volatile Storage of Multiple Wiper Positions
- Power On Recall. Loads Saved Wiper Position on Power Up.
- Standby Current < 5µA Max
- V<sub>CC</sub>: 2.7V to 5.5V Operation
- 2.5K $\Omega$ , 10K $\Omega$  Total Pot Resistance
- Endurance: 100, 000 Data Changes per Bit per Register
- 100 yr. Data Retention
- 14-Lead TSSOP, 16-Lead SOIC
- Low Power CMOS

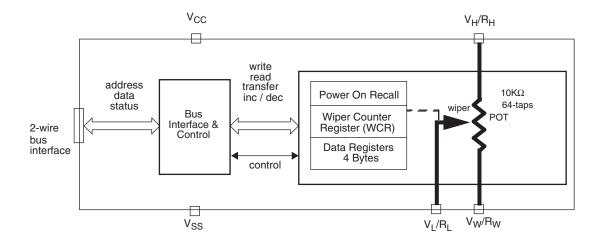
#### **DESCRIPTION**

The X9429 integrates a single digitally controlled potentiometer (XDCP) on a monolithic CMOS integrated circuit.

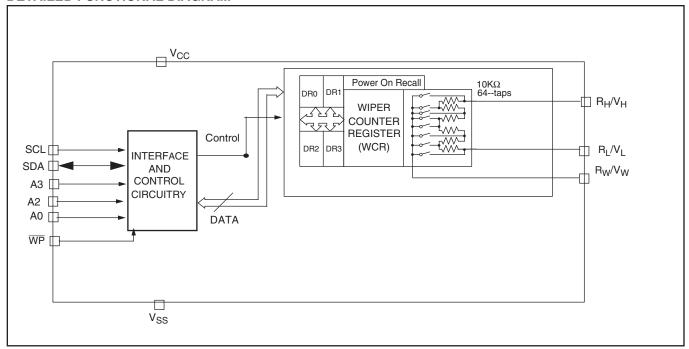
The digital controlled potentiometer is implemented using 63 resistive elements in a series array. Between each element are tap points connected to the wiper terminal through switches. The position of the wiper on the array is controlled by the user through the 2-wire bus interface. The potentiometer has associated with it a volatile Wiper Counter Register (WCR) and a four non-volatile Data Registers that can be directly written to and read by the user. The contents of the WCR controls the position of the wiper on the resistor array though the switches. Powerup recalls the contents of the default data register (DR0) to the WCR.

The XDCP can be used as a three-terminal potentiometer or as a two terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

#### **BLOCK DIAGRAM**



#### **DETAILED FUNCTIONAL DIAGRAM**



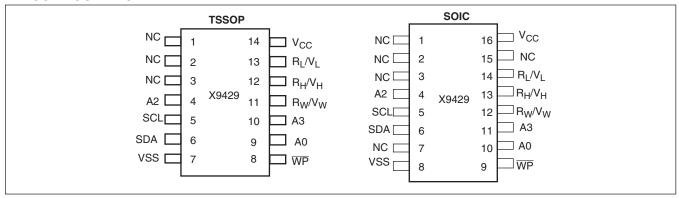
#### CIRCUIT LEVEL APPLICATIONS

- · Vary the gain of a voltage amplifier
- Provide programmable dc reference voltages for comparators and detectors
- Control the volume in audio circuits
- Trim out the offset voltage error in a voltage amplifier circuit
- Set the output voltage of a voltage regulator
- Trim the resistance in Wheatstone bridge circuits
- Control the gain, characteristic frequency and Q-factor in filter circuits
- Set the scale factor and zero point in sensor signal conditioning circuits
- Vary the frequency and duty cycle of timer ICs
- Vary the dc biasing of a pin diode attenuator in RF circuits
- Provide a control variable (I, V, or R) in feedback circuits

#### SYSTEM LEVEL APPLICATIONS

- Adjust the contrast in LCD displays
- Control the power level of LED transmitters in communication systems
- Set and regulate the DC biasing point in an RF power amplifier in wireless systems
- Control the gain in audio and home entertainment systems
- Provide the variable DC bias for tuners in RF wireless systems
- Set the operating points in temperature control systems
- Control the operating point for sensors in industrial systems
- Trim offset and gain errors in artificial intelligent systems

#### **PIN CONFIGURATION**



#### **PIN ASSIGNMENTS**

TSSOP pin	SOIC pin	Symbol	Brief Description
1	1	NC	No Connect
2	2	NC	No Connect
3	3	NC	No Connect
4	4	A2	Device Address for 2-wire bus.
5	5	SCL	Serial Clock for 2-wire bus.
6	6	SDA	Serial Data Input/Output for 2-wire bus.
7	8	V <sub>SS</sub>	System Ground
8	9	WP	Hardware Write Protect
9	10	A0	Device Address for 2-wire bus.
10	11	А3	Device Address for 2-wire bus.
11	12	R <sub>W</sub> / V <sub>W</sub>	Wiper Terminal of the Potentiometer.
12	13	R <sub>H</sub> / V <sub>H</sub>	High Terminal of the Potentiometer.
13	14	R <sub>L</sub> / V <sub>L</sub>	Low Terminal of the Potentiometer.
14	16	V <sub>CC</sub>	System Supply Voltage
	15	NC	No Connect
	7	NC	No Connect

#### **PIN DESCRIPTIONS**

#### Host Interface Pins

# Serial Clock (SCL)

The SCL input is used to clock data into and out of the X9429.

#### Serial Data (SDA)

SDA is a bidirectional pin used to transfer data into and out of the device. It is an open drain output and may be wire-ORed with any number of open drain or open collector outputs. An open drain output requires the use of a pull-up resistor. For selecting typical values, refer to the guidelines for calculating typical values on the bus pull-up resistors graph.

## Device Address (A<sub>0</sub>, A<sub>2</sub>, A<sub>3</sub>)

The Address inputs are used to set the least significant 3 bits of the 8-bit slave address. A match in the slave address serial data stream must be made with the Address input in order to initiate communication with the X9429. A maximum of 8 devices may occupy the 2-wire serial bus.

#### Potentiometer Pins

# $R_H/V_H$ , $R_L/V_L$

The  $R_H/V_H$  and  $R_L/V_L$  inputs are equivalent to the terminal connections on either end of a mechanical potentiometer.

## R<sub>W</sub>/V<sub>W</sub>

The wiper outputs are equivalent to the wiper output of a mechanical potentiometer.

#### Hardware Write Protect Input WP

The WP pin when low prevents nonvolatile writes to the Data Registers.

#### PRINCIPLES OF OPERATION

The X9429 is a highly integrated microcircuit incorporating a resistor array and its associated registers and counters and the serial interface logic providing direct communication between the host and the XDCP potentiometers.

#### **Serial Interface**

The X9429 supports a bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master will always initiate data transfers and provide the clock for both transmit and receive operations. Therefore, the X9429 will be considered a slave device in all applications.

#### **Clock and Data Conventions**

Data states on the SDA line can change only during SCL LOW periods ( $t_{LOW}$ ). SDA state changes during SCL HIGH are reserved for indicating start and stop conditions.

#### **Start Condition**

All commands to the X9429 are preceded by the start condition, which is a HIGH to LOW transition of SDA while SCL is HIGH ( $t_{\mbox{HIGH}}$ ). The X9429 continuously monitors the SDA and SCL lines for the start condition and will not respond to any command until this condition is met.

#### **Stop Condition**

All communications must be terminated by a stop condition, which is a LOW to HIGH transition of SDA while SCL is HIGH.

## **Acknowledge**

Acknowledge is a software convention used to provide a positive handshake between the master and slave devices on the bus to indicate the successful receipt of data. The transmitting device, either the master or the slave, will release the SDA bus after transmitting eight bits. The master generates a ninth clock cycle and during this period the receiver pulls the SDA line LOW to acknowledge that it successfully received the eight bits of data.

The X9429 will respond with an acknowledge after recognition of a start condition and its slave address and once again after successful receipt of the command byte. If the command is followed by a data byte the X9429 will respond with a final acknowledge.

#### **Array Description**

The X9429 is comprised of a resistor array. The array contains 63 discrete resistive segments that are connected in series. The physical ends of the array are equivalent to the fixed terminals of a mechanical potentiometer ( $V_H/R_H$  and  $V_L/R_L$  inputs).

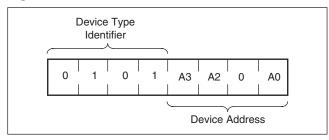
At both ends of the array and between each resistor segment is a CMOS switch connected to the wiper  $(V_W/R_W)$  output. Within each individual array only one switch may be turned on at a time. These switches are controlled by the Wiper Counter Register (WCR). The six bits of the WCR are decoded to select, and enable, one of sixty-four switches.

The WCR may be written directly, or it can be changed by transferring the contents of one of four associated Data Registers into the WCR. These Data Registers and the WCR can be read and written by the host system.

#### **Device Addressing**

Following a start condition the master must output the address of the slave it is accessing. The most significant four bits of the slave address are the device type identifier (refer to Figure 1). For the X9429 this is fixed as 0101[B].

Figure 1. Slave Address



The next four bits of the slave address are the device address. The physical device address is defined by the state of the  $A_0$ ,  $A_2$ , and  $A_3$  inputs. The X9429 compares the serial data stream with the address input state; a successful compare of all three address bits is required for the X9429 to respond with an acknowledge. The  $A_0$ ,  $A_2$ , and  $A_3$  inputs can be actively driven by CMOS input signals or tied to  $V_{CC}$  or  $V_{SS}$ .

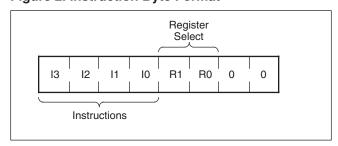
# **Acknowledge Polling**

The disabling of the inputs, during the internal nonvolatile write operation, can be used to take advantage of the typical 5ms EEPROM write cycle time. Once the stop condition is issued to indicate the end of the nonvolatile write command the X9429 initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the device slave address. If the X9429 is still busy with the write operation no ACK will be returned. If the X9429 has completed the write operation an ACK will be returned, and the master can then proceed with the next operation.

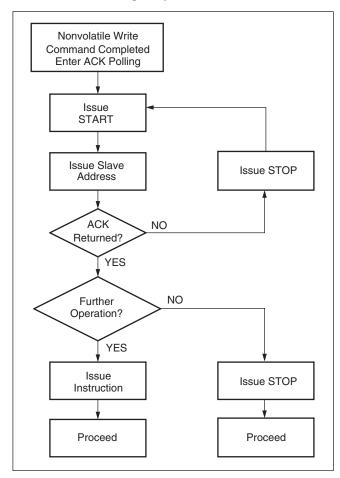
#### **Instruction Structure**

The next byte sent to the X9429 contains the instruction and register pointer information. The four most significant bits are the instruction. The next four bits point to one of four associated registers. The format is shown below in Figure 2.

Figure 2. Instruction Byte Format



Flow 1. ACK Polling Sequence

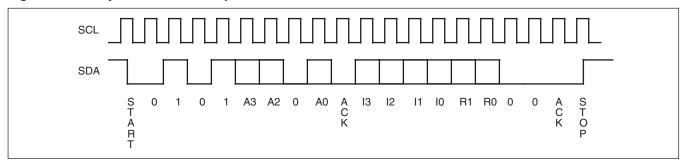


The four high order bits define the instruction. The next two bits (R1 and R0) select one of the four registers that is to be acted upon when a register oriented instruction is issued. Bits 0 and 1 are defined to be 0.

Four of the seven instructions end with the transmission of the instruction byte. The basic sequence is illustrated in Figure 3. These two-byte instructions exchange data between the Wiper Counter Register and one of the Data Registers. A transfer from a Data Register to a Wiper Counter Register is essentially a write to a static RAM. The response of the wiper to this action will be delayed  $t_{WRL}$ . A transfer from the Wiper Counter Register (current wiper position), to a Data Register is a write to nonvolatile memory and takes a minimum of  $t_{WR}$  to complete.

Four instructions require a three-byte sequence to complete. These instructions transfer data between the host and the X9429; either between the host and one of the Data Registers or directly between the host and the Wiper Counter Register. These instructions are:

Figure 3. Two-Byte Instruction Sequence



Read Wiper Counter Register (read the current wiper position of the selected pot), write Wiper Counter Register (change current wiper position of the selected pot), read Data Register (read the contents of the selected nonvolatile register) and write Data Register (write a new value to the selected Data Register). The sequence of operations is shown in Figure 4.

The Increment/Decrement command is different from the other commands. Once the command is issued and the X9429 has responded with an acknowledge, the master can clock the selected wiper up and/or down in one segment steps; thereby, providing a fine tuning capability to the host. For each SCL clock pulse ( $t_{HIGH}$ ) while SDA is HIGH, the selected wiper will move one resistor segment towards the  $V_H/R_H$  terminal. Similarly, for each SCL clock pulse while SDA is LOW, the selected wiper will move one resistor segment towards the  $V_L/R_L$  terminal. A detailed illustration of the sequence and timing for this operation are shown in Figures 5 and 6 respectively.

**Table 1. Instruction Set** 

			In	stru	ction	Set			
Instruction	l <sub>3</sub>	l <sub>2</sub>	I <sub>1</sub>	I <sub>0</sub>	R <sub>1</sub>	R <sub>0</sub>	X <sub>1</sub>	X <sub>0</sub>	Operation
Read Wiper Counter Register	1	0	0	1	0	0	0	0	Read the contents of the Wiper Counter Register
Write Wiper Counter Register	1	0	1	0	0	0	0	0	Write new value to the Wiper Counter Register
Read Data Register	1	0	1	1	1/0	1/0	0	0	Read the contents of the Data Register pointed to by $R_1$ – $R_0$
Write Data Register	1	1	0	0	1/0	1/0	0	0	Write new value to the Data Register pointed to by $R_1-R_0$
XFR Data Register to Wiper Counter Register	1	1	0	1	1/0	1/0	0	0	Transfer the contents of the Data Register pointed to by R <sub>1</sub> –R <sub>0</sub> to its Wiper Counter Register
XFR Wiper Counter Register to Data Regis- ter	1	1	1	0	1/0	1/0	0	0	Transfer the contents of the Wiper Counter Register to the Data Register pointed to by R <sub>1</sub> –R <sub>0</sub>
Increment/Decrement Wiper Counter Register	0	0	1	0	0	0	0	0	Enable Increment/decrement of the Wiper Counter Register

Note: (1) 1/0 = data is one or zero

Figure 4. Three-Byte Instruction Sequence

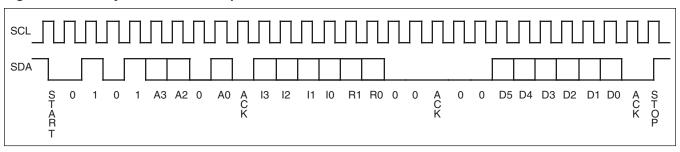


Figure 5. Increment/Decrement Instruction Sequence

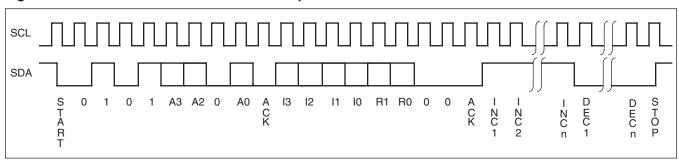
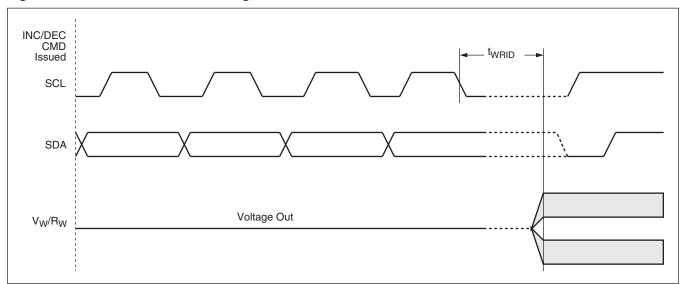


Figure 6. Increment/Decrement Timing Limits



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Figure 7. Acknowledge Response from Receiver

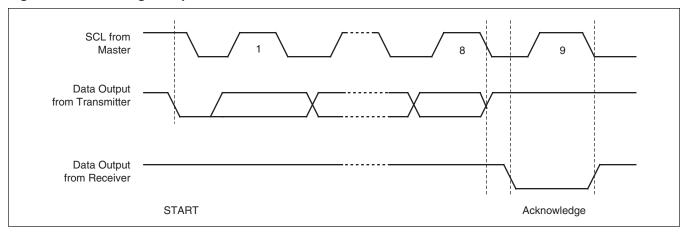
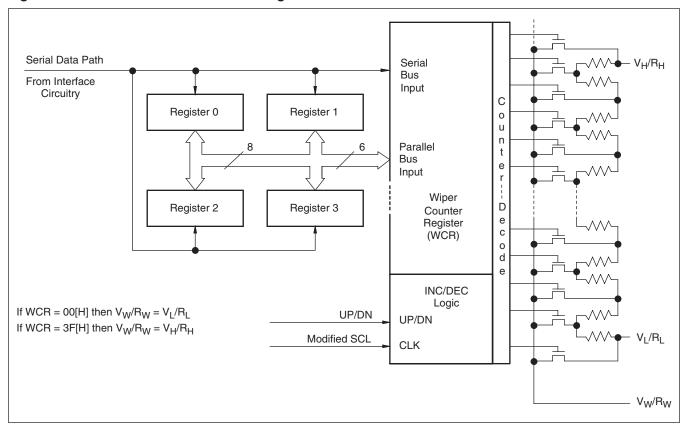


Figure 8. Detailed Potentiometer Block Diagram



#### **DETAILED OPERATION**

The potentiometer has a Wiper Counter Register and four Data Registers. A detailed discussion of the register organization and array operation follows.

#### **Wiper Counter Register**

The X9429 contains a Wiper Counter Register. The Wiper Counter Register can be envisioned as a 6-bit parallel and serial load counter with its outputs decoded to select one of sixty-four switches along its resistor array. The contents of the WCR can be altered in four ways: it may be written directly by the host via the write Wiper Counter Register instruction (serial load); it may be written indirectly by transferring the contents of one of four associated Data Registers via the XFR Data Register instruction (parallel load); it can be modified one step at a time by the Increment/ Decrement instruction. Finally, it is loaded with the contents of its Data Register zero (DR0) upon power-up.

The WCR is a volatile register; that is, its contents are lost when the X9429 is powered-down. Although the register is automatically loaded with the value in DR0 upon power-up, it should be noted this may be different from the value present at power-down.

## **Data Registers**

The potentiometer has four nonvolatile Data Registers. These can be read or written directly by the host and data can be transferred between any of the four Data Registers and the Wiper Counter Register. It should be noted all operations changing data in one of these registers is a nonvolatile operation and will take a maximum of 10ms.

If the application does not require storage of multiple settings for the potentiometer, these registers can be used as regular memory locations that could possibly store system parameters or user preference data.

#### **Register Descriptions**

#### Data Registers, (6-Bit), Nonvolatile

D5	D4	D3	D2	D1	D0	
NV	NV	NV	NV	NV	NV	
(MSB)					(LSB)	

Four 6-bit Data Registers for each XDCP.

 - {D5~D0}: These bits are for general purpose not volatile data storage or for storage of up to four different wiper values. The contents of Data Register 0 are automatically moved to the Wiper Counter Register on power-up.

## Wiper Counter Register, (6-Bit), Volatile

WP5	WP4	WP3	WP2	WP1	WP0	
V	V	V	V	V	V	
(MSB)					(LSB)	

One 6-bit wiper counter register for each XDCP.

- {D5~D0}: These bits specify the wiper position of the respective XDCP. The Wiper Counter Register is loaded on power-up by the value in Data Register 0. The contents of the WCR can be loaded from any of the other Data Register or directly. The contents of the WCR can be saved in a DR.

## **Instruction Format**

Notes: (1) "MACK"/"SACK": stands for the acknowledge sent by the master/slave.

- (2) "A3 ~ A0": stands for the device addresses sent by the master.
- (3) "X": indicates that it is a "0" for testing purpose but physically it is a "don't care" condition.
- (4) "I": stands for the increment operation, SDA held high during active SCL phase (high).
- (5) "D": stands for the decrement operation, SDA held low during active SCL phase (high).

# **Read Wiper Counter Register (WCR)**

S T			e ty tifie	•		de\ ddre			S		stru opc							S A	(8		wip t by					A)	M A	S
A R T	0	1	0	1	A 3	A 2	0	A 0	C K	1	0	0	1	0	0	0	0	C K	0	0	W P 5	W P 4	W P 3	W P 2	W P 1	W P 0	C K	О Р

# **Write Wiper Counter Register (WCR)**

S T		vice den	,			de\ ddre			S A		stru opc							S A	(s	ent	wip by ı					A)	S A	S T
A R T	0	1	0	1	A 3	A 2	0	A 0	C K	1	0	1	0	0	0	0	0	C K	0	0	W P 5	W P 4	W P 3	W P 2	W P 1	W P 0	C K	O P

# Read Data Register (DR)

S T		vice den	•	•			/ice		S A		stru opc				_	stei		S A	(8		er by	•				A)	M A	S T
A R T	0	1	0	1	A 3	A 2	0	A 0	C K	1	0	1	1	R 1	R o	0	0	C K	0	0	<b>V</b> P 5	W P 4	W P 3	WP2	W P 1	W P 0	C K	O P

## Write Data Register (DR)

				_	•		•	•																					
S	de	vice	e ty	ре		dev	/ice	:	0	in	stru	ıctio	on	- 1	regi	ste	r			wip	oer	pos	itio	n/d	ata		٥	٥	
T	ic	den	tifie	r	ac	ddre	ess	es	A		орс	ode	)	a	ddre	ess	es	A	(se	ent	by ı	mas	ster	on	SD	A)		T	HIGH-VOLTAGE
A R	0	1	0	1	Α	Α	0	Α	С	1	1	0	0	R	R	0	0	С	0	0	W P	W	W	W	W P	W	С	0	WRITE CYCLE
T		•		•	3	2		0	K	ľ	·			1	0			K	ľ		5	4	3	2	1	0	K	P	

# XFR Data Register (DR) to Wiper Counter Register (WCR)

S T		vice	-	-		dev ddre			S A			ode			regi ddre			S A	S
R T	0	1	0	1	A 3	A 2	0	A 0	C K	1	1	0	1	R 1	R 0	0	0	C K	O P

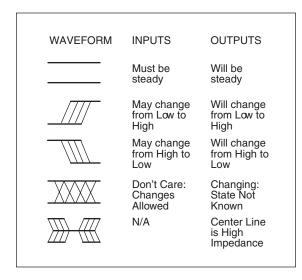
# XFR Wiper Counter Register (WCR) to Data Register (DR)

S		vice	•	•		dev			s		stru				egi			s	s	
A R T	0	den 1	0	er 1	A 3	A 2	0	A 0	A C K	1	opc 1	1	0	R 1	R 0	0	es 0	A C K	Т О Р	HIGH-VOLTAGE WRITE CYCLE

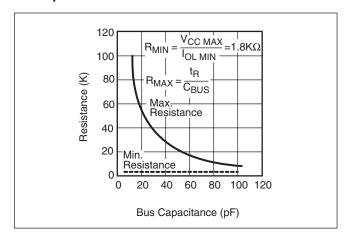
# **Increment/Decrement Wiper Counter Register (WCR)**

S T			e ty tifie	•			/ice		S A			ode						S			eme by r				S T
R T	0	1	0	1	A 3	A 2	0	A 0	C K	0	0	1	0	0	0	0	0	C	I/ D	I/ D			I/ D	I/ D	O P

## **SYMBOL TABLE**



# Guidelines for Calculating Typical Values of Bus Pull-Up Resistors



# **ABSOLUTE MAXIMUM RATINGS**

Temperature under bias :65°C to -	+135°C
Storage temperature:65°C to +	-150°C
Voltage on SCL, SDA any address input	
with respect to V <sub>SS</sub> :1V	to +7V
$\Delta V =   (V_H - V_L)  $	5V
Lead temperature (soldering, 10 seconds)	300°C
I <sub>W</sub> (10 seconds)	. ±6mA

# **COMMENT**

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device (at these or any other conditions above those listed in the operational sections of this specification) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

Temperature	Min.	Max.
Commercial	0°C	+70°C
Industrial	-40°C	+85°C

Device Supply Voltage (V <sub>CC</sub> ) Limit		
X9429	5V ±10%	
X9429-2.7	2.7V to 5.5V	

# **ANALOG CHARACTERISTICS** (Over recommended operating conditions unless otherwise stated.)

			Lim	its		
Symbol	Parameter	Min.	Тур.	Max.	Unit	<b>Test Conditions</b>
	End to End Resistance Tolerance			±20	%	
	Power rating			50	mW	25°C, each pot
I <sub>W</sub>	Wiper current			±3	mA	
R <sub>W</sub>	Wiper resistance		150	250	Ω	Wiper current = $\pm$ 1mA, $V_{CC}$ = 5V
			400	1000	Ω	Wiper current = $\pm$ 1mA, $V_{CC}$ = 3V
V <sub>TERM</sub>	Voltage on any $V_H/R_H$ or $V_L/R_L$ pin	V <sub>SS</sub>		V <sub>CC</sub>	V	$V_{SS} = 0V$
	Noise		-120		dBV	Ref: 1kHz
	Resolution (4)		1.6		%	
	Absolute Linearity (1)			±1	MI <sup>(3)</sup>	V <sub>w(n)(actual)</sub> —V <sub>w(n)(expected)</sub>
	Relative Linearity (2)			±0.2	MI <sup>(3)</sup>	V <sub>w(n + 1)</sub> —[V <sub>w(n) + MI</sub> ]
	Temperature Coefficient of $R_{TOTAL}$		±300		ppm/°C	
	Ratiometric Temperature Coefficient			±20	ppm/°C	
C <sub>H</sub> /C <sub>L</sub> /C <sub>W</sub>	Potentiometer Capacitances		10/10/25		pF	See Circuit #3, Spice Macromodel

#### D.C. OPERATING CHARACTERISTICS (Over the recommended operating conditions unless otherwise specified.)

		Limits				
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
I <sub>CC1</sub>	V <sub>CC</sub> supply current (nonvolatile write)			1	mA	f <sub>SCL</sub> = 400kHz, SDA = Open, Other Inputs = V <sub>SS</sub>
I <sub>CC2</sub>	V <sub>CC</sub> supply current (move wiper, write, read)			100	μΑ	f <sub>SCL</sub> = 400kHz, SDA = Open, Other Inputs = V <sub>SS</sub>
I <sub>SB</sub>	V <sub>CC</sub> current (standby)			5	μΑ	$SCL = SDA = V_{CC}$ , Addr. = $V_{SS}$
I <sub>LI</sub>	Input leakage current			10	μΑ	$V_{IN} = V_{SS}$ to $V_{CC}$
I <sub>LO</sub>	Output leakage current	kage current 10		μΑ	V <sub>OUT</sub> = V <sub>SS</sub> to V <sub>CC</sub>	
V <sub>IH</sub>	Input HIGH voltage	V <sub>CC</sub> x 0.7		V <sub>CC</sub> x 0.5	V	
V <sub>IL</sub>	Input LOW voltage	-0.5 V <sub>CC</sub>		V <sub>CC</sub> x 0.1	V	
V <sub>OL</sub>	Output LOW voltage			0.4	V	I <sub>OL</sub> = 3mA

Notes: (1) Absolute linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.

- (2) Relative linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.
- (3) MI = RTOT/63 or  $(R_H R_L)/63$ , single pot
- (4) Typical = individual array resolutions.

#### **ENDURANCE AND DATA RETENTION**

Parameter Min.		Unit
Minimum endurance	100,000	Data changes per bit per register
Data retention	100	Years

## **CAPACITANCE**

Symbol	Test	Max.	Unit	Test Conditions
C <sub>I/O</sub> <sup>(5)</sup>	Input/output capacitance (SDA)	8	pF	V <sub>I/O</sub> = 0V
C <sub>IN</sub> <sup>(5)</sup>	Input capacitance (A0, A2,and A3 and SCL)	6	pF	$V_{IN} = 0V$

#### **POWER-UP TIMING**

Symbol	Parameter	Min.	Тур.	Max.	Unit
t <sub>R</sub> V <sub>CC</sub> <sup>(6)</sup>	V <sub>CC</sub> Power up ramp rate	0.2		50	V/msec

#### POWER-UP AND POWER-DOWN REQUIREMENTS

There are no restrictions on the power-up or power-down conditions of  $V_{CC}$  and the voltage applied to the potentiometer pins provided that  $V_{CC}$  is always more positive than or equal to  $V_H$ ,  $V_L$ , and  $V_W$ , i.e.,  $V_{CC} \ge V_H$ ,  $V_L$ ,  $V_W$ . The  $V_{CC}$  ramp rate spec is alway in effect.

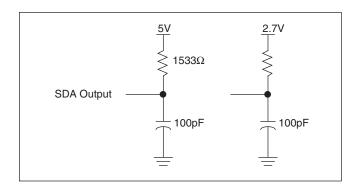
Notes: (5) This parameter is periodically sampled and not 100% tested

(6) Sample tested only.

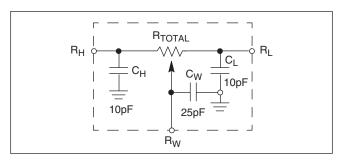
# **A.C. TEST CONDITIONS**

Input pulse levels	V <sub>CC</sub> x 0.1 to V <sub>CC</sub> x 0.9
Input rise and fall times	10ns
Input and output timing level	V <sub>CC</sub> x 0.5

# **EQUIVALENT A.C. LOAD CIRCUIT**



# **Circuit #3 SPICE Macro Model**



# **AC TIMING** (Over recommended operating conditions)

Symbol	Parameter	Min.	Max.	Unit
f <sub>SCL</sub>	Clock frequency	100	400	kHz
t <sub>CYC</sub>	Clock cycle time	2500		ns
tHIGH	Clock high time	600		ns
t <sub>LOW</sub>	Clock low time	1300		ns
t <sub>SU:STA</sub>	Start setup time	600		ns
t <sub>HD:STA</sub>	Start hold time	600		ns
t <sub>SU:STO</sub>	Stop setup time	600		ns
t <sub>SU:DAT</sub>	SDA data input setup time	100		ns
t <sub>HD:DAT</sub>	SDA data input hold time	30		ns
t <sub>R</sub>	SCL and SDA rise time		300	ns
t <sub>F</sub>	SCL and SDA fall time		300	ns
t <sub>AA</sub>	SCL low to SDA data output valid time		900	ns
t <sub>DH</sub>	SDA data output hold time	50		ns
T <sub>I</sub>	Noise suppression time constant at SCL and SDA inputs	50		ns
t <sub>BUF</sub>	Bus free time (prior to any transmission)	1300		ns
t <sub>SU:WPA</sub>	WP, A0, A2, A3 setup time	0		ns
t <sub>HD:WPA</sub>	WP, A0, A2, A3 hold time	0		ns

# **HIGH-VOLTAGE WRITE CYCLE TIMING**

Symbol	Parameter	Тур.	Max.	Unit
t <sub>WR</sub>	High-voltage write cycle time (store instructions)	5	10	ms

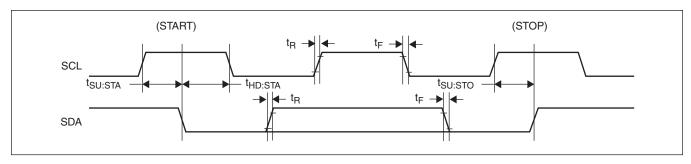
# **XDCP TIMING**

Symbol	Parameter	Min.	Max.	Unit
t <sub>WRPO</sub>	Wiper response time after the third (last) power supply is stable		10	μs
t <sub>WRL</sub>	Wiper response time after instruction issued (all load instructions)		10	μs
t <sub>WRID</sub>	Wiper response time from an active SCL/SCK edge (increment/decrement instruction)		10	μs

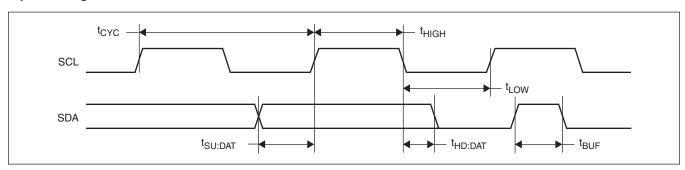
Note: (8) A device must internally provide a hold time of at least 300ns for the SDA signal in order to bridge the undefined region of the falling edge of SCL.

# **TIMING DIAGRAMS**

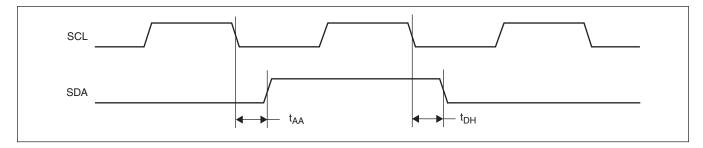
# **START and STOP Timing**



# **Input Timing**

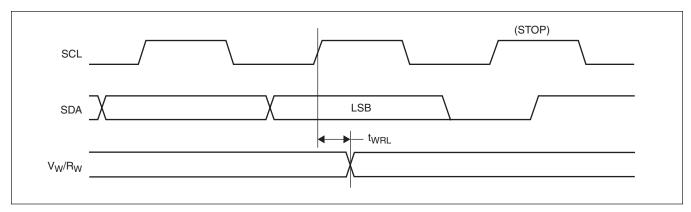


# **Output Timing**

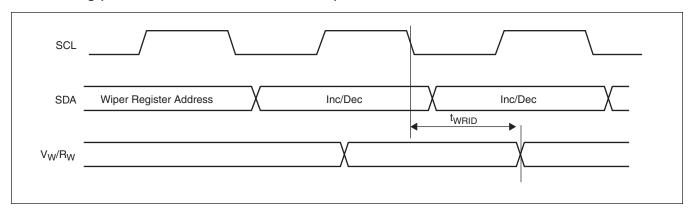


Characteristics subject to change without notice.

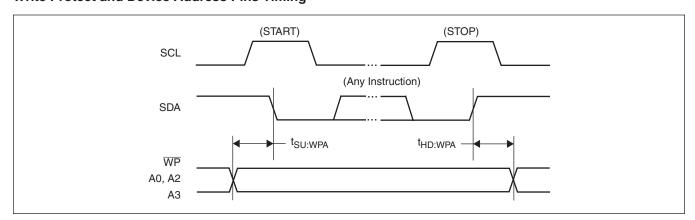
# **XDCP Timing (for All Load Instructions)**



# **XDCP Timing (for Increment/Decrement Instruction)**

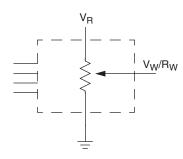


# **Write Protect and Device Address Pins Timing**

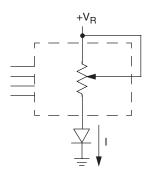


# **APPLICATIONS INFORMATION**

# **Basic Configurations of Electronic Potentiometers**



Three terminal Potentiometer; Variable voltage divider

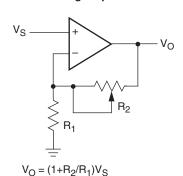


Two terminal Variable Resistor; Variable current

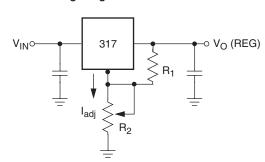
# **Application Circuits**

REV 1.1.6 7/8/03

## **Noninverting Amplifier**

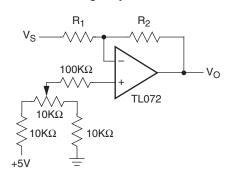


## **Voltage Regulator**

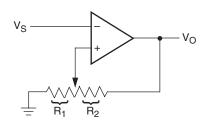


 $V_O (REG) = 1.25V (1+R_2/R_1)+I_{adj} R_2$ 

#### Offset Voltage Adjustment



## **Comparator with Hysteresis**



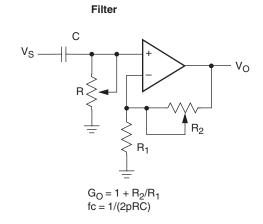
Characteristics subject to change without notice.

$$\begin{split} &V_{UL} = \{R_1/(R_1 + R_2)\} \ V_O(max) \\ &V_{LL} = \{R_1/(R_1 + R_2)\} \ V_O(min) \end{split}$$

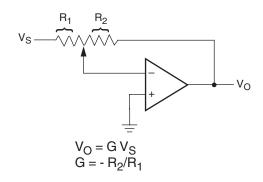
# **Application Circuits (continued)**

# Attenuator $R_2$ $R_1$ $V_{O}$ All $R_S = 10k\Omega$

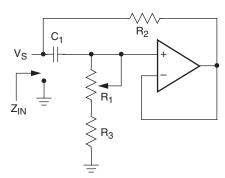
$$V_O = G V_S$$
  
-1/2 \le G \le +1/2



# **Inverting Amplifier**

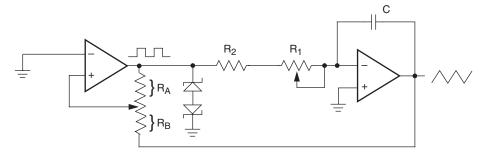


## **Equivalent L-R Circuit**



$$\begin{split} Z_{IN} = R_2 + s \; R_2 \; (R_1 + R_3) \; C_1 = R_2 + s \; \text{Leq} \\ (R_1 + R_3) >> R_2 \end{split}$$

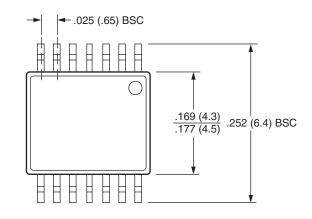
## **Function Generator**

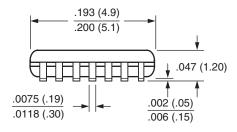


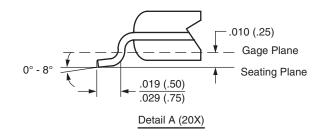
 $frequency \propto R_1,\,R_2,\,C$  $amplitude \propto R_A,\,R_B$ 

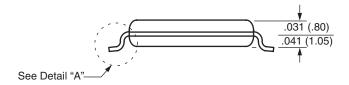
# **PACKAGING INFORMATION**

# 14-Lead Plastic, TSSOP, Package Type V







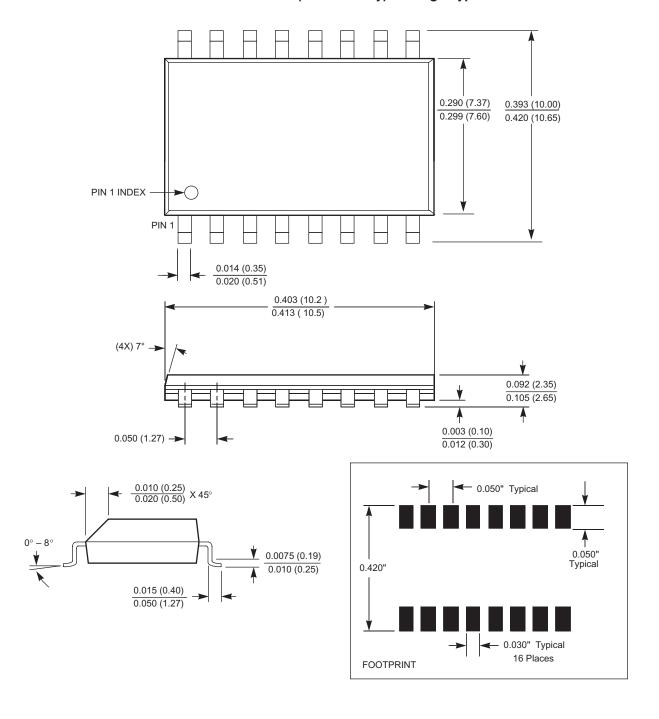


NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

Characteristics subject to change without notice.

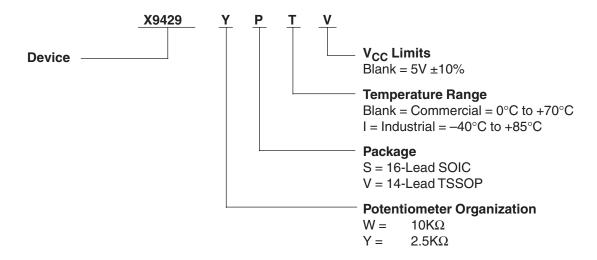
## **PACKAGING INFORMATION**

# 16-Lead Plastic SOIC (300 Mil Body) Package Type S



NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

## **Ordering Information**



\*Note: P package only available as X9429WP16I-2.7 for prototyping. Other resistor values not available in package.

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